

APPROVAL SHEET

MF12Q/R, MF08Q/R, MF06Q/R, MF04Q/R $\pm 1\%$, $\pm 0.5\%$, $\pm 0.25\%$, $\pm 0.1\%$, $\pm 0.05\%$ TC50 , TC25

Anti-Sulfuration
Precision Thin Film Chip Resistor
Size 1206, 0805, 0603, 0402
AEC-Q200 Qualified

RoHS Exemption free and Lead free products
Halogen free



*Contents in this sheet are subject to change without prior notice.



FEATURES

- 1. SMD TaN thin film resistor
- 2. Special passivation layer on resistive film
- 3. AEC-Q200 qualified
- 4. Products with lead free terminations meet RoHS requirements
- 5. Sulfur resistant (per ASTM B809-95 humid vapor test
- 6. AEC-Q200 ESD rated class 1C
- 7. +/-0.02% is upon the customer request.
- 8. Laser trimmed to any value
- 9. 100% visual inspection

APPLICATIONS

- Automotive electronics
- Medical equipment
- Measuring instrument
- Industrial Equipment

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive layer that is applied to the top surface of the substrate. The composition of the resistive layer is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For environmental soldering issue, the outer layer of these end terminations is a Lead-free solder .

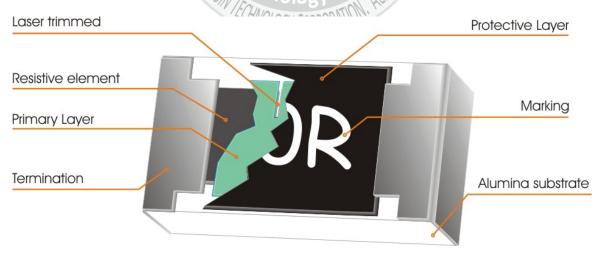


Fig 1. Construction of Chip-R MFxxQ



QUICK REFERENCE DATA

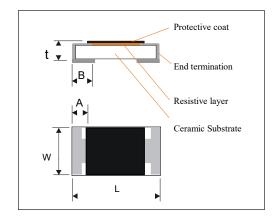
Item	General Specification						
Series No.	MF12Q&R	MF08Q&R	MF06Q&R	MF04Q&R			
Size code	1206 (3216)	0805 (2012)	0603 (1608)	0402 (1005)			
Resistance Tolerance	±1%, ±0.5%, ±0.25%, ±0.1%, ±0.05%						
Resistance Range	10Ω ~ 1ΜΩ	10Ω ~ 350ΚΩ	40Ω ~ 180ΚΩ	40Ω ~ 50ΚΩ			
TCR (ppm/°C)		±50 / ±25	ppm/°C				
Max. dissipation at T _{amb} =85°C	0.4W	0.2W	0.15W	0.0625W			
Max. Operation Voltage (DC or RMS)	200V	100V	75V	50V			
Max. Overload Voltage (DC or RMS)	400V	200V	150V	100V			
Operating Temperature Range		- 55∼ +175°C					

Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by $RCWV = \sqrt{Rated \ Power \ \times Resistance \ Value} \ or \ Max. \ RCWV \ listed \ above, \ whichever \ is \ lower.$

DIMENSIONS:(unit:mm)

Туре	MF12	MF08	MF06	MF04
L	3.00 ± 0.10	2.00 ± 0.10	1.55 ± 0.10	1.00 ± 0.10
w	1.50 ± 0.10	1.25 ± 0.10	0.80 ± 0.10	0.50 ± 0.05
Α	0.40 ± 0.20	0.35 ± 0.20	0.30 ± 0.20	0.25 ± 0.15
В	0.40 ± 0.20	0.40 ± 0.20	0.30 ± 0.15	0.30 ± 0.10
t	0.60 ± 0.15	0.50 ± 0.15	0.45 ± 0.15	0.30 ± 0.10



CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

MF06	Q	1003	В	Т	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination
MF12 : 1206	Q: TCR ±50ppm	3 significant digits	F:±1%	T : 7"Taped & Reeled	code
MF08: 0805	R: TCR ±25ppm	followed by no. of	D:±0.5%		L : Sn base
MF06:0603		zeros	C: ±0.25%		(lead free)
MF04: 0402		102Ω =1020	B: ±0.1%		
		37.4ΚΩ =3742	A: ±0.05%		
		220Ω =2200			

Reeled tape packaging: 8mm width paper taping.

5,000pcs/reel for MF06, MF08, MF12

10,000pcs/reel for MF04

MARKING

- No marking for 0402 size
- 3 digits marking for 0603 size

5 digital marking for 6555 5126															
Nomina	l resistan	ce	Description												
1.E24 s	eries	2 s	ignificant of	digits foll	lowed by I	No. of ze	eros .		KF	471					
			Exam	ple	11/4 3					C	\				
			RE	SISTAN	ICE	4.7Ω	47Ω	47	70Ω	4K70	47K0	470)K 4	M70	
			3 di	gits mar	king	4R7	470	- 4	71	472	473	47	4	475	
2.E96 s	eries	Th	e 1st two d	ligit code	es are refe	erring to	the CODI	E on the	table the	e 3rd co	de is the i	ndex of	resistano	e value	
2.2000	01100		peat value											o valuo.	
		100	•				-		_	L	2			_	_
		-	Code	Z			$\frac{X}{0^{-1}}$ —	10 ⁰	B	C	$\frac{D}{10^3}$	E 10⁴		= 0 ⁵ –	G 10⁵
			Multiplier	10	10	1	U	10	101	10 ²	10	10	1	U.	10
			Exam	ple						227					
			RE	SISTAN	ICE	1.78Ω	17.8Ω	17	78Ω	1K78	17K8	178	3K 1	M78	
			3 di	gits mar	king	25Y	25X		25A	25B	25C	25	D :	25E	
3. Rema	ark	Th	ere is no n	narking f	or the iter	ns not u	nder E24	and E96	S series.	/					
						ZZCHA	MACUE	Manar							
	DE table:					11//	YLUGY LL	IKLOUL	1110						
CODE	R value	CODE	R-value	CODE	R-Value	CODE	R-value	CODE	R-value	CODE	R-value	CODE	R-value	CODE	R-value
01	100	13	133	25	178	37	237	49	316	61	422	73	562	85	750
02	102	14	137	26	182	38	243	50	324	62	432	74	576	86	768
03	105	15	140	27	187	39	249	51	332	63	442	75	590	87	787
04	107	16	143	28	191	40	255	52	340	64	453	76	604	88	806
05	110	17	147	29	196	41	261	53	348	65	464	77	619	89	825
06	113	18	150	30	200	42	267	54	357	66	475	78	634	90	845
07	115	19	154	31	205	43	274	55	365	67	487	79	649	91	866
08	118	20	158	32	210	44	280	56	374	68	499	80	665	92	887
09	121	21	162	33	215	45	287	57	383	69	511	81	681	93	909
10	124	22	165	34	221	46	294	58	392	70	523	82	698	94	931
11	127	23	169	35	226	47	301	59	402	71	536	83	715	95	953
12	130	24	174	36	232	48	309	60	412	72	549	84	732	96	976

4 digits marking for 0805/1206 size:

Each resistor is marked with a four digits code on the protective coating to designate the nominal resistance value. The first 3 digits are significant, and the fourth digit indicates the number of multiple to follow. For non E24/E96 series, no marking is applied.

Example

RESISTANCE	10Ω	47Ω	470Ω	6800Ω	47000Ω	470000Ω	1000000Ω
4 digits marking	10R0	47R0	4700	6801	4702	4703	1004

Page 4 of 11 ASC_MFxxQ&R_V07 Jun - 2025



FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E192 & E24 series for resistors with a tolerance of $\pm 1\%$, $\pm 0.5\%$, $\pm 0.25\%$, $\pm 0.1\%$, $\pm 0.05\%$. The values of the E24/E192 series are in accordance with "IEC publication 60063".

DERATING

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

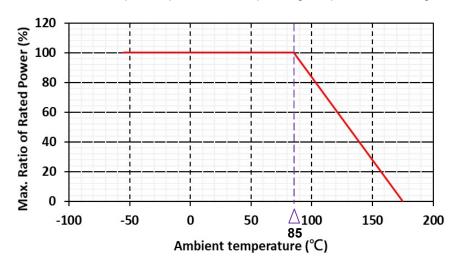


Fig. 2 Maximum dissipation in percentage of rated power as a function of ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

Storage and Handling Conditions:

- 1. Products are recommended to be used up within two years since operation date as ensured shelf life. Check solderability in case shelf life extension is needed.
- 2. To store products with following condition:

Temperature :5 to 40°C

Humidity :20 to 70% relative humidity

- 3. Caution:
 - a. Don't store products in a corrosive environment such as sulfide, chloride gas, or acid. It may cause oxdization of electrode, which easily be resulted in poor soldering.
 - b. To store products on the shelf and avoid exposure to moisture.
 - c. Don't expose products to excessive shock, vibration, direct sunlight and so on.

Page 5 of 11

ASC_MFxxQ&R_V07

Jun - 2025



SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds within lead-free solder bath. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering profile and condition that provide reliable joints without any damage are given in Fig 3. and Table 1.

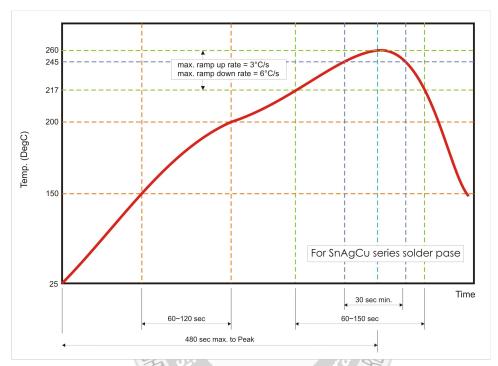


Fig. 3 Infrared soldering profile for Chip Resistors

Table 1. Infrared soldering condition for Chip Resistors

Temperature Condition	Exposure Time
Average ramp-up rate (217°C to 260°C)	Less than 3°C/second
Between 150 and 200°C	Between 60-120 seconds
> 217°C	Between 60-150 seconds
Peak Temperature	260°C +0/-5°C
Time within 245°C	Min. 30 seconds
Ramp-down rate (Peak to 217°C)	Less than 6°C/second
Time from 25°C to Peak	No greater than 480 seconds



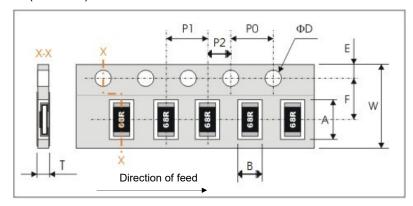
TEST AND REQUIREMENTS

TEST	PROCEDURE	REQUIREMENT
Electrical Characteristics	- DC resistance values measurement	Within the specified tolerance
IEC 60115-1 4.8	- Temperature Coefficient of Resistance (T.C.R)	
	Natural resistance change per change in degree centigrade.	
	$\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)} t_1 : 20^{\circ}\text{C} + 5^{\circ}\text{C} - 1^{\circ}\text{C}$	
	R ₁ : Resistance at reference temperature (20°C+5°C/-1°C)	
	R ₂ : Resistance at test temperature (-55°C or +125°C)	
Short time overload (S.T.O.L) IEC60115-1 4.13	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	ΔR/R max. ±(0.1%+0.02Ω)
Resistance to soldering	Un-mounted chips completely immersed for 10±1second in a	no visible damage
heat(R.S.H)	SAC solder bath at 260°C±5°C	Δ R/R max. ±(0.1%+0.02Ω)
AEC-Q200-15		
Solderability	· · · · · · · · · · · · · · · · · · ·	good tinning (>95% covered)
IEC 60068-2-58	SAC solder bath at 235°C±5°C	no visible damage
Temperature cycling JESD22 method JA-104	1000 cycles, -55°C ~ +125°C, dwell time 5~10min	Δ R/R max. ±(0.1%+0.02Ω)
JESD22 Method JA-104	1000 cycles, -55°C ~ +155°C, dwell time 5~10min	Δ R/R max. ±(0.2%+0.02Ω)
Bias Humidity AEC-Q200-7	1000 +48/-0 hours, loaded with 10% rated power in humidity chamber controller at +85°C / 85%RH	Δ R/R max. ±(0.1%+0.02 Ω)
High Temperature	1000 +48/-0 hours, loaded with RCWV or Vmax in chamber	Δ R/R max. \pm (0.1%+0.02 Ω)
Operating Life	controller 85 ±2°C, 1.5 hours on and 0.5 hours off	
MIL-STD-202 Method 108	4000 hours at 125°C up noward	AD/D may 1/0.19/10.02()
High Temperature Exposure	1000 hours at 125°C, un-powered	Δ R/R max. \pm (0.1%+0.02 Ω)
AEC-Q200-3	1000 hours at 155°C, un-powered	Δ R/R max. ±(0.15%+0.02 Ω)
	1000 hours at 175°C, un-powered	Δ R/R max. ±(0.30%+0.02 Ω)
Moisture Resistance AEC-Q200 -6	65±2°C, 80~100% RH, 10 cycles, 24 hours/ cycle	Δ R/R max. \pm (0.1%+0.02 Ω)
MIL-STD-202 Method 106	*C/71/VOLOGY CORPORALION	
Mechanical Shock	1/2 Sino Pulco / 1500g Pook / Volocity 15 Aff/coc	Δ R/R max. ±(0.1%+0.02Ω)
MIL-STD-202 Method 213	1/2 Sine Pulse / 1500g Peak / Velocity 15.4ft/sec	$\Delta N N \text{ max. } \pm (0.170 \pm 0.0252)$
Vibration	5 g's for 20 min , 12 cycles each of 3 orientations	Δ R/R max. \pm (0.1%+0.02 Ω)
MIL-STD-202 Method 204	o g s for 20 min , 12 dyoles each of a chemications	△ 170 TO 10.0232)
Terminal strength	1 kg for 60 s	No broken
AEC-Q200-6	1	21011011
Board flex	Bending 2mm for 60 sec	Δ R/R max. \pm (0.1%+0.02 Ω)
AEC-Q200-005		
Flower of sulfur	105±2°C, duration 1000hours.	0402 :
ASTM-B809-95		Δ R/R max. ±(0.2%+0.02Ω)
		Others: $\Delta R/R$ max. $\pm (0.1\% + 0.02\Omega)$
ESD	0402 : 500V	Δ R/R max. \pm (0.5%+0.02 Ω)
AEC-Q200-002	0603 : 1000V	No visible damage
	0805 : 1500V	admago
	1206 : 2000V	



PACKAGING

Tape specifications (unit :mm)

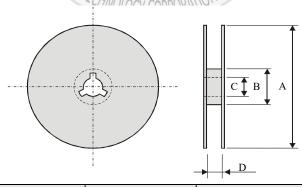


Series No.	А	В	W	F	E
MF12	3.60±0.20	2.00±0.20	8.00±0.30	3.50±0.20	1.75±0.10
MF08	2.40±0.20	1.65±0.20	8.00±0.30	3.50±0.20	1.75±0.10
MF06	1.90±0.20	1.10±0.20	8.00±0.30	3.50±0.20	1.75±0.10
MF04	1.20±0.10	0.7±0.10	8.00±0.30	3.50±0.05	1.75±0.10

《火》、场股份各

Series No.	P1	P0	P2	ΦD	Т			
MF12	4.00±0.10	4.00±0.10	2.00±0.10	Φ 1.50 $^{+0.1}_{-0.0}$	Max. 1.0			
MF08	4.00±0.10	4.00±0.10	2.00±0.10	$\Phi 1.50 {}^{+0.1}_{-0.0}$	Max. 1.0			
MF06	4.00±0.10	4.00±0.10	2.00±0.10	Ф1.50 +0.1 -0.0	0.65±0.05			
MF04	2.00±0.10	4.00±0.10	2.00±0.10	Ф1.50 +0.1 -0.0	0.45±0.05			

Reel dimensions



Symbol	A	В	С	D	
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	9.0±0.5	

Taping quantity

- Chip resistors 5,000 pcs per reel (MF06, MF08, MF12)
- Chip resistors 10,000 pcs per reel (MF04)

Page 8 of 11

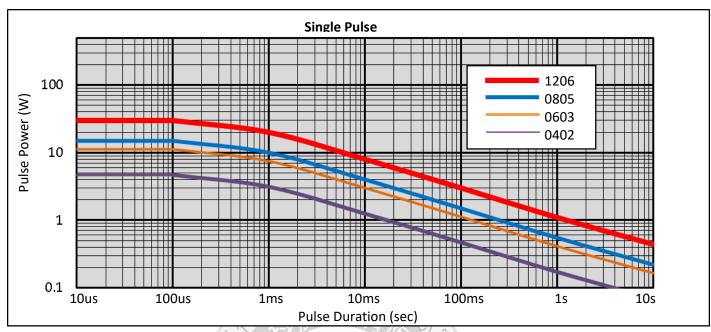
ASC_MFxxQ&R_V07

Jun - 2025



PULSE LOAD PERFORMANCE:

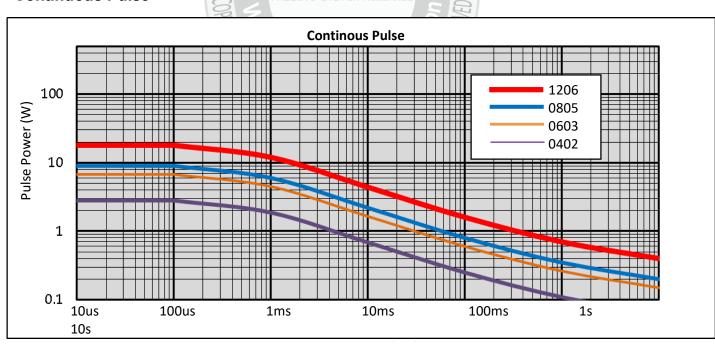
Single Pulse:



Single Pulse for $R \ge 10 \Omega$

50 rectangular pulse amplitudes are applied to the component at intervals of 60seconds, permissible the resistance to be varied by \pm (0.5% R + 0.01 Ω).

Continuous Pulse:



Continuous Pulse for $R \ge 10 \Omega$

Continuous load is a pulse period generated by the repetitive rectangular pulse amplitude, the applied power dissipation is at a rated power of 70 $^{\circ}$ C.

Permissible the resistance to be varied by \pm (0.5% R + 0.01 Ω).

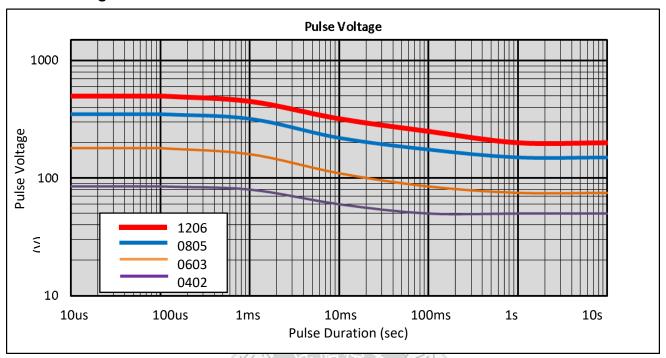
Page 9 of 11

ASC_MFxxQ&R _V07

Jun - 2025

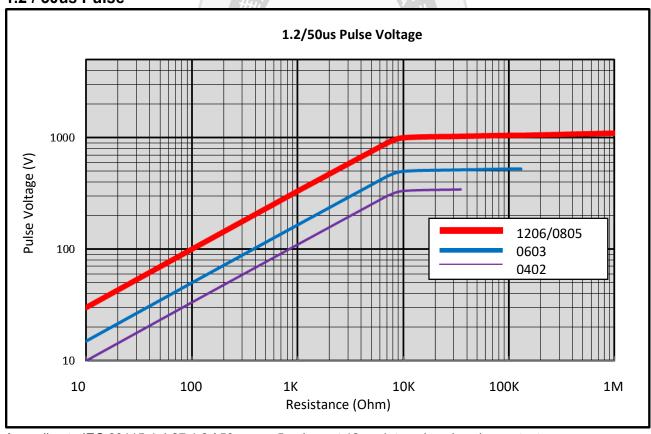


Pulse Voltage:



Pulse Surge Overload:

1.2 / 50us Pulse

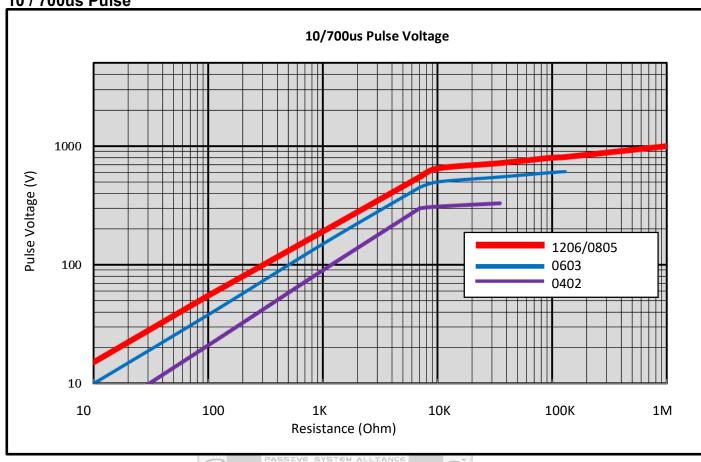


According to IEC 60115-1 4.27 1.2 / 50us use 5 pulses at 12sec intervals pulse shapes test resistor, permissible the resistance to be varied by \pm (0.5% R + 0.01 Ω).

Page 10 of 11 ASC_MFxxQ&R_V07 Jun - 2025



10 / 700us Pulse



According to IEC 60115-1 4.27 10 1700us use 10 pulses at 60sec intervals pulse shapes test resistor, permissible the resistance to be varied by \pm (0.5% R + 0.01 Ω).